

A LISTING OF THE CLAIMS

1. (Previously Presented) A baking system including a plate for receiving a wafer to be baked, a heater for heating the plate, and a cooling apparatus for cooling the plate, the cooling apparatus comprising:

a heatpipe for cooling the plate using vaporization of a coolant therein, the heatpipe arranged in proximity to the plate with the heater disposed therebetween;

a coolant storage tank for supplying the coolant into the heatpipe when the plate is cooled and for storing the coolant supplied to the heatpipe when the plate is heated; and

a thermostatic element for maintaining an approximately constant temperature of the coolant supplied into the heatpipe when the plate is cooled.

2. (Previously Presented) The baking system as claimed in claim 1, wherein the coolant storage tank comprises a coolant flowing element for flowing the coolant into the heatpipe when the plate is cooled.

3. (Previously Presented) The baking system as claimed in claim 1, wherein the thermostatic element comprises:

a cooling water storage tank for circulating cooling water through the heatpipe; and

a cooling water supply pipeline, which is a path of the cooling water, that extends into the heatpipe and provides flow communication between the heatpipe and the cooling water storage tank.

4. (Previously Presented) The baking system as claimed in claim 3, wherein the cooling water supply pipeline has a valve between the cooling water storage tank and the heatpipe.

5. (Previously Presented) The baking system as claimed in claim 1, further comprising a coolant supply pipeline for providing flow communication between the coolant storage tank and the heatpipe.

6. (Previously Presented) The baking system as claimed in claim 5, wherein the coolant supply pipeline has a valve between the coolant storage tank and the heatpipe.

7. (Previously Presented) The baking system as claimed in claim 1, wherein the heatpipe includes a ceiling portion and internal side portions.

8.- 9. (Cancelled)

10. (Original) The baking system as claimed in claim 2, wherein the coolant flowing element is a heater disposed adjacent to the coolant storage tank.

11. (Original) The baking system as claimed in claim 2, wherein the coolant flowing element is a heater integrated with the coolant storage tank in a single body.

12. (Previously Presented) The baking system as claimed in claim 7, wherein the heatpipe comprises a wick on the ceiling portion and a wick on the internal side portions of the heatpipe.

13. (Previously Presented) The baking system as claimed in claim 12, wherein the wick on the ceiling portion and the wick on the internal side portions of the heatpipe has a linear shape, a spiral shape or a radial shape.

14. (Previously Presented) The baking system as claimed in claim 13, wherein the wick on the ceiling portion has a different shape than the wick on the internal side portions of the heatpipe.

15. (Original) The baking system as claimed in claim 7, further comprising:  
a wick plate having a plurality of planar wicks installed on the ceiling portion of the heatpipe; and

a wick formed on the internal side portions of the heatpipe to guide the coolant to flow toward the wick plate.

16. (Previously Presented) The baking system as claimed in claim 15, wherein the wick formed on the internal side portions of the heatpipe has a linear shape, a spiral shape or a radial shape.

17. (Cancelled)

18. (Previously Presented) The baking system as claimed in claim 7, further comprising a wick plate installed on the ceiling portion and a wick plate installed on the internal side portions of the heatpipe.

19.-20. (Cancelled)

21. (Original) The baking system as claimed in claim 1, wherein the coolant is selected from the group consisting of acetone, methanol, water, and distilled water.